

Advanced Semiconductor Packaging Market in China - Manufacturing and Consumption, Outlook and Forecast 2020-2026

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Abstracts

Advanced packaging is a general grouping of a variety of distinct techniques, including 2.5D, 3D-IC, fan-out wafer-level packaging and system-in-package, etc.

This report contains market size and forecasts of Advanced Semiconductor Packaging in China, including the following market information:

China Advanced Semiconductor Packaging Market Revenue, 2015-2020, 2021-2026, (\$ millions)

China Advanced Semiconductor Packaging Market Consumption, 2015-2020, 2021-2026, (M Units)

China Advanced Semiconductor Packaging Production Capacity, 2015-2020, 2021-2026, (M Units)

Top Five Competitors in China Advanced Semiconductor Packaging Market 2019 (%)

The global Advanced Semiconductor Packaging market was valued at 14030 million in 2019 and is projected to reach US\$ 18520 million by 2026, at a CAGR of 7.2% during the forecast period. While the Advanced Semiconductor Packaging market size in China was US\$ XX million in 2019, and it is expected to reach US\$ XX million by the end of 2026, with a CAGR of XX% during 2020-2026.

MARKET MONITOR GLOBAL, INC (MMG) has surveyed the Advanced Semiconductor Packaging manufacturers, suppliers, distributors and industry experts on the impacts of the COVID-19 pandemic on businesses, with top challenges including ingredients and raw material delays, component and packaging shortages, reduced/cancelled orders from clients and consumers, and closures of production lines in some impacted areas.

This report also analyses and evaluates the COVID-19 impact on Advanced

Semiconductor Packaging production and consumption in China

Total Market by Segment:

China Advanced Semiconductor Packaging Market, By Type, 2015-2020, 2021-2026 (\$ millions) & (M Units)

China Advanced Semiconductor Packaging Market Segment Percentages, By Type, 2019 (%)

Fan-Out Wafer-Level Packaging (FO WLP)

Fan-In Wafer-Level Packaging (FI WLP)

Flip Chip (FC)

2.5D/3D

Others

Flip chip is the most used type in 2019, with about 44.29% market share.

China Advanced Semiconductor Packaging Market, By Application, 2015-2020, 2021-2026 (\$ millions) & (M Units)

China Advanced Semiconductor Packaging Market Segment Percentages, By Application, 2019 (%)

Telecommunications

Automotive

Aerospace and Defense

Medical Devices

Consumer Electronics

Consumer electronics is the most important market, with market shares of 39% in 2019.

Competitor Analysis

The report also provides analysis of leading market participants including:

Total Advanced Semiconductor Packaging Market Competitors Revenues in China, by Players 2015-2020 (Estimated), (\$ millions)

Total Advanced Semiconductor Packaging Market Competitors Revenues Share in China, by Players 2019 (%)

Total China Advanced Semiconductor Packaging Market Competitors Sales, by Players 2015-2020 (Estimated), (M Units)

Total China Advanced Semiconductor Packaging Market Competitors Sales Market Share by Players 2019 (\$ millions)

Further, the report presents profiles of competitors in the market, including the following:

Amkor

SPIL

Intel Corp

JCET

ASE

TFME

TSMC

Huatian

Powertech Technology Inc

UTAC

Nepes

Walton Advanced Engineering

Kyocera

Chipbond

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